

SURFACE MOUNT DUAL, SILICON SWITCHING DIODES



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD2836 and CMPD2838 types are ultra-high speed switching diodes manufactured by the epitaxial planar process, in an epoxy molded surface mount package, designed for high speed switching applications.



The following configurations are available:

CMPD2836 CMPD2838	DUAL, COMMON ANODE DUAL, COMMON CATHODE	MARKING C MARKING C		
MAXIMUM RA	TINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage		V _{RRM}	75	V
Average Forward Current		۱ _O	200	mA
Peak Forward	Current	IFM	300	mA
Power Dissipa	tion	PD	350	mW
Operating and	Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resis	tance	ΘJA	357	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (TA=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _R	V _R =50V			100	nA
ΒV _R	Ι _R =100μΑ	75			V
VF	I _F =10mA			1.0	V
V_{F}	I _F =50mA			1.0	V
V_{F}	I _F =100mA			1.2	V
CT	V _R =0, f=1.0MHz		1.5	4.0	pF
t _{rr}	$I_R=I_F=10mA$, $R_L=100\Omega$, Rec. to 1.0mA			4.0	ns

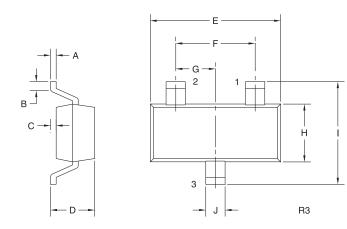
R6 (25-January 2010)





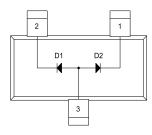
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SOT-23 CASE - MECHANICAL OUTLINE



DIMENSIONS									
	INCHES		MILLIMETERS						
SYMBOL	MIN	MAX	MIN	MAX					
А	0.003	0.007	0.08	0.18					
В	0.006	-	0.15	-					
С	-	0.005	-	0.13					
D	0.035	0.043	0.89	1.09					
E	0.110	0.120	2.80	3.05					
F	0.075		1.90						
G	0.037		0.95						
Н	0.047	0.055	1.19	1.40					
	0.083	0.098	2.10	2.49					
J	0.014	0.020	0.35	0.50					
SOT-23 (REV: R3)									

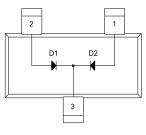
PIN CONFIGURATIONS



CMPD2836

LEAD CODE: 1) Cathode D2 2) Cathode D1 3) Anode D1, D2

MARKING CODE: CA2



CMPD2838

LEAD CODE: 1) Anode D2 2) Anode D1 3) Cathode D1, D2

MARKING CODE: CA6

R6 (25-January 2010)

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

· Custom bar coding for shipments

Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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